

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION**

In re Application of:

Chen et al.

Atty. Docket: TI-37133

Serial No.: TBD

Art Unit: TBD

Filed: Herewith

Examiner: TBD

**For: METHOD TO FORM SHALLOW TRENCH ISOLATION WITH
ROUNDED UPPER CORNER FOR ADVANCED
SEMICONDUCTOR CIRCUITS**

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

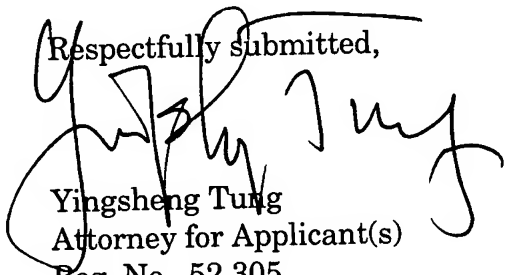
INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97 & 1.98

Sir:

Applicants wish to bring to the attention of the Patent and Trademark Office the information noted on the enclosed form PTO-1449. Pursuant to the new rule, copies of only the non-patent literature cited are being submitted. Please charge any necessary fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668. Charge any additional fee required or credit any overpayment to the same.

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Respectfully submitted,


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